MICRO BLADE & BEAM SOCKET & HEADER

(0.40 mm) .0158" PITCH • SS4/ST4 SERIES

SS4 Mates: ST4

ST4 Mates:

SPECIFICATIONS

Insulator Material: Contact Material: Phosphor Bronze
Plating: Au or Sn over 50 μ" (1.27 μm) Ni **Operating Temp Range:** -55 °C to +125 °C **Current Rating:** 1.6 A per pin (2 pins powered) Voltage Rating: 155 VAC/219 VDC

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max

POSITIONS PER ROW

> –10, –20, -30, -40, -50

STYLE

-3.00 $= 3.00 \, \text{mm}$

-3.50 $= 3.50 \, \text{mm}$ **PLATING OPTION**

= 10 µ"

(0.25 µm) Gold on contact, Matte Tin on tail

K

(Required in

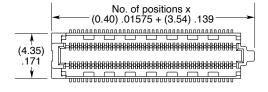
-K = (3.50 mm) .138" DIA Polyimide Film Pick & Place Pad

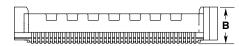
(Required in callout)

"X"R

-TR = Tape & Reel

-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks)







Б

| LEAD STYLE | A | В |
|---------------|----------------|----------------|
| -3.00 | (2.85) .112 | (3.50) .138 |
| -3.50 | (3.35) | (4.00) .157 |

MATED HEIGHT* SS4 LEAD STYLE ST4 LEAD STYLE -3.50 (4.00 mm) (4.50 mm) -1.00 .157" .177" (4.50 mm) (5.00 mm) -1.50 .177" .197"

(5.50 mm) (6.00 mm)

.236"

.217" *Processing conditions will affect mated height

POSITIONS

-10, -20,

-30, -40, -50

= 1.00 mm-1.50= 1.50 mm

> -2.50 $= 2.50 \, \text{mm}$

-1.00

= 10 µ" (0.25 µm)

PLATING

OPTION

Gold on contact, Matte Tin on tail

(Required in callout)

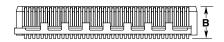
-P = Pick & Place Pad (Required in callout)

"X"R

-TR = Tape & Reel

-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks)

No. of positions x (0.40) .01575 + (1.58) .062 (3.70)`.146





| LEAD STYLE | A | В |
|---------------|----------------|----------------|
| -1.00 | (1.00) .039 | (3.08) |
| -1.50 | (1.50) .059 | (3.58) .141 |
| -2.50 | (2.50) .098 | (4.58) .180 |

Note:

Some lengths, styles and options are non-standard, non-returnable.